

# SY58051U

Ultra-Precision CML AnyGate<sup>®</sup> with Internal Input and Output Termination

## Precision Edge<sup>®</sup>

### **General Description**

The SY58051U is an ultra-fast, low jitter universal logic gate with a guaranteed maximum data or clock throughput of 10.7Gbps or 7GHz, respectively. This AnyGate<sup>®</sup> differential logic device will produce many logic functions of two Boolean variables, such as AND, NAND, OR, NOR, DELAY, or NEGATION.

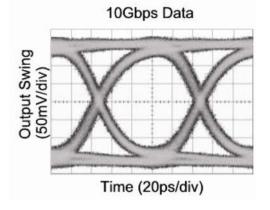
The SY58051U differential inputs include a unique internal termination design that allows access to the termination network throughout a V<sub>T</sub> pin. This feature allows the device to easily interface to different logic standards, both AC- and DC-coupled without external resistor-bias and termination networks. The result is a clean, stub-free, low-jitter interface solution. The differential CML output is optimized for environments with internal 50 $\Omega$  source termination and a 400mV output swing.

The SY58051U operates from a 2.5 or 3.3V supply, and is guaranteed over the full industrial temperature range

(-40°C to +85°C). The SY58051U is part of Micrel's Precision Edge  $^{\ensuremath{\mathbb{R}}}$  product family.

All support documentation can be found on Micrel's web site at <u>www.micrel.com</u>.

# **Typical Application**





#### **Features**

- Three matched-delay input pair provide any logic function: AND, NAND, OR, NOR
- Guaranteed AC performance over temperature and
- voltage:
  - DC to > 10.7Gbps data rate throughput
  - DC to > 7GHz clock f<sub>MAX</sub>
  - <190ps Any In-to-Out t<sub>pd</sub>
  - t<sub>r</sub> / t<sub>f</sub> < 60ps
- Ultra low-jitter design:
  - <1ps<sub>RMS</sub> random jitter
  - <10ps<sub>PP</sub> deterministic jitter
  - <10ps<sub>PP</sub> total jitter (clock)
- Unique input termination and VT pin accepts DCcoupled and AC-coupled inputs (CML, PECL)
- Internal 50Ω output source termination
- Typical 400mV CML output swing ( $R_{IN} = 50\Omega$ )
- Internal  $50\Omega$  input termination
- Power supply 2.5V ±5% or 3.3V ±10%
- -40°C to 85°C temperature range
- Available in a 16-pin (3mm × 3mm) QFN<sup>®</sup> package

### Applications

- Data communication systems
- OC-192, OC192+FEC
- All SONET OC-3—OC-768 applications
- All Fibre Channel applications
- All GigE applications

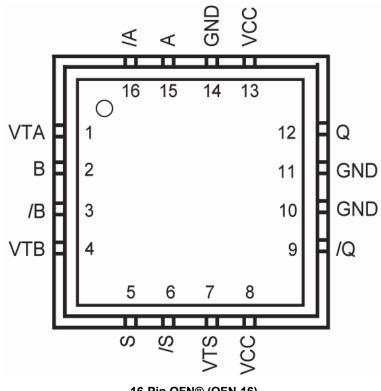
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# **Ordering Information**

Part Number	Package Type	Operational Range	Package Marking
SY58051UMG <sup>(3)</sup>	Pb-free QFN-16	Industrial	051U with Pb-Free bar-line indicator
SY58051UMGTR <sup>(2, 3)</sup>	Pb-free QFN-16	Industrial	051U with Pb-Free bar-line indicator

# **Pin Configuration**



16-Pin QFN® (QFN-16)

# **Pin Description**

Pin Number	Pin Name	Pin Function
1	VT	Input Termination Center Tap: Each of the two inputs, (A, /A) terminates to this pin through a50 $\Omega$ resistor. The VTA pin provides a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section for more details.
15, 16 2, 3	A, /A B, /B	Differential Input: These input pairs are the two data inputs to the device. Each pin of a pair 2, 3 B, /B internally terminates to the VTA or VTB pin to $50\Omega$ . Note that these inputs will default to an indeterminate state if left open. See "Input Interface Applications" section for more details.
4	VTB	Input Termination Center Tap: Each of the two inputs, (B, /B) terminates to this pin through a $50\Omega$ resistor. The VTB pin provides a center-tap to a termination network for maximum interface flexibility.
5, 6	S, /S	Differential Input: This input pair is the select input to the device. Each pin of this pair internally terminates to the VTS pin to $50\Omega$ . Note that this input will default to an indeterminate state if left open. See "Input Interface Applications" section for more details.
7	VTS	Input Termination Center Tap: Each of the two inputs, S, /S terminates to this pin. The VTS pin provides a center-tap to a termination network for maximum interface flexibility.
8, 13	VCC	Positive Power Supply. Bypass with 0.1µF 0.01µF low ESR capacitors.
12, 9	Q, /Q	Differential Output: This CML output pair is the output of the device. It is a logic function of the A, B, and S inputs. See "Truth Tables" for details.
10, 11, 14	GND	Ground. Exposed pad must be connected to the same potential as GND pin.

 $(\overline{\alpha} \cdot \overline{\beta})$ 

/Q

Н

Н

L

# **Truth Tables**

А	/A	В	/B	S	/S	Q	/Q
0	1	Х	Х	0	1	0	1
1	0	Х	Х	0	1	1	0
Х	Х	0	1	1	0	0	1
Х	Х	1	0	1	0	1	0

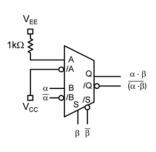
α

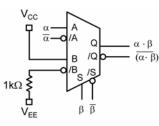
В

L

Н

Н





O

/Q

A /A

в /B

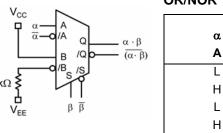
в

 $V_{\text{cc}}$ 

V<sub>cc</sub> 

500Ω V<sub>EE</sub>

500Ω



α

 $\overline{\alpha}$ 

β

ß

L	L	Н	L	Н
L	Н	Н	Н	L
OR/NOR				
α		β	α • β	$\overline{(\alpha + \beta)}$
Α	В	В	Q	/Q
L	Н	L	L	Н
Н	Н	L	Н	L
L	Н	Н	Н	L

н

β

в

L

L

α•β

Q

L

L

Н

# **DELAY/NEGATION**

AND/NAND

Α

L

L

α Α	В	S	α Q	α /Q
L		S	L	Н
Н		S	Н	L

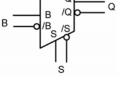
### **DELAY/NEGATION**

А	β Β	S	β Q	_β /Q
	L	Н	L	Н
	Н	Н	Н	L

#### 2:1 MUX

S	Q	/Q
L H	A B	Ā
		В





/Α

# Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage (V <sub>CC</sub> )	
Input Voltage (V <sub>IN</sub> )	0.5V to V <sub>CC</sub>
CML Output Voltage (V <sub>OUT</sub> ) V <sub>CC</sub> to -1 Termination Current <sup>(3)</sup>	.0V to V <sub>CC</sub> +0.5V
Termination Current <sup>(3)</sup>	
Source or Sink Current on V <sub>TA</sub> ' V <sub>TB</sub> ' V <sub>TS</sub>	±60mA
Input Current	
Source or Sink Current on A, /A, B, /B, S	S, /S±30mA
Lead Temperature (soldering, 20 sec.)	+260°C
Storage Temperature (T <sub>S</sub> .)	65°C to +150°C

## DC Electrical Characteristics <sup>(5)</sup>

TA =  $-40^{\circ}$ C to  $+85^{\circ}$ C, unless otherwise noted.

# **Operating Ratings**<sup>(2)</sup>

Supply Voltage (V <sub>CC</sub> )	+2.375V to +2.625V
	or +3.0°C to +85°C
Ambient Temperature (T <sub>A</sub> ) Package Thermal Resistance <sup>(4)</sup>	40°C to +85°C
Package Thermal Resistance <sup>(4)</sup>	
PDIP (θ <sub>JA</sub> )	
Still-Air	61°C/W
QFN (ψ <sub>JB</sub> )	

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Vcc	Power Supply	V <sub>CC</sub> = 2.5V.	2.375	2.5	2.625	V
VCC		V <sub>CC</sub> = 3.3V.	3.0	3.3	3.6	V
lcc	Power Supply Current	No Load, max. V <sub>CC</sub> .		55	70	mA
R <sub>DIFF_IN</sub>	Differential Input Resistance		80	100	120	Ω
NDIFF_IN	(A-to/A, B-to-/B or S-to/S)		00	100	120	12
R <sub>IN</sub>	Input Resistance		40	50	60	Ω
• 500	(A-to-V <sub>TA</sub> , B-to-V <sub>TB</sub> or S-to-V <sub>TS</sub> )		+0	50	00	12
VIH	Input HIGH Voltage	Note 6	1.2		Vcc	V
VIH	(A, /A or B, /B or S, /S)	NOLE O			V CC	v
VIL	Input LOW Voltage	Note 6	0		V <sub>IH</sub> -0.1	mV
VIL	(A, /A or B, /B or S, /S)	NOLE O			VIH-0.1	ΠV
V <sub>IN</sub>	Input Voltage Swing	Note 6	100			mV
VIN	(A, /A or B, /B or S, /S)	See Figure 2a.	100			IIIV
M	Differential Input Voltage Swing	Note 6	200			m) (
VDIFF_IN	IA-, /AI or IB-, /BI or S-, /SI	See Figure 2b.	200			mV
	Input Current	Note 6			21	~^^
I IN	(A, /A or B, /B or S, /S)	Note 6			21	mA

#### Notes:

1. Permanent device damage may occur if the ratings in the "Absolute Maximum Ratings" section are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Due to the limited drive capability use for input of the same package only.
- 4. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.  $\Psi_{JB}$  uses 4-layer  $\theta_{JA}$  n still-air, unless otherwise stated.
- 5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- 6. Due to the internal termination (see Figure 1a) the input current depends on the applied voltages at A, /A and  $V_{TA}$  inputs, the B, /B and  $V_{TB}$  inputs or the S, /S and  $V_{TS}$  inputs. Do not apply a combination of voltages that causes the input current to exceed the maximum limit.

# CML Electrical Characteristics<sup>(5)</sup>

Symbol	Parameter	Condition	Min.	Тур	Max	Units
V <sub>сн</sub>	Output HIGH Voltage Q, /Q		V <sub>cc</sub> _0.020		V <sub>cc</sub> 3.6	V
V <sub>OUT</sub>	Output Voltage Swing Q, /Q	See Figure 2a.	325	400	500	mV
V <sub>DIFF_OUT</sub>	Differential Output Voltage Swing	See Figure 2b.	650	800	1000	mV
	Q, /Q					
Rout	Output Source Impedance		40	50	60	Ω
	Q, /Q					

# AC Electrical Characteristics<sup>(8)</sup>

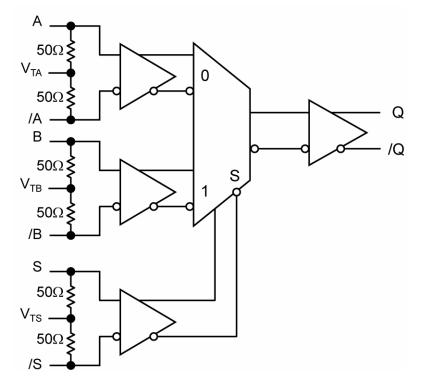
 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%; R<sub>L</sub> =100 $\Omega$  across output pair or equivalent; T<sub>A</sub> = -40°C to +85°C; unless otherwise noted.

Symbol	Parameter	Condition	Min	Тур	Мах	Units
Fmax	Maximum Operating Frequency	Clock	10.7	7		GHz
		NRZ Data	10.7			Gbps
t <sub>pd</sub>	Propagation Delay Any Input (A, B, S)-to-Q		70		190	ps
t <sub>skew</sub>	Part-to-Part Skew	Note 9			100	ps
tjitter	Data					
	Random Jitter (RJ)	Note 10			1	ps <sub>RMS</sub>
	Deterministic Jitter (DJ)	Note 11			10	ps <sub>PP</sub>
	Clock					
	Cycle-to-Cycle Jitter (RJ)	Note 12			1	<b>ps</b> <sub>RMS</sub>
	Total Jitter (TJ)	Note 13			10	ps <sub>PP</sub>
T <sub>R,</sub> t <sub>f</sub>	Output Rise/Fall Times (20% to 80%)	At full output swing.	20		60	ps

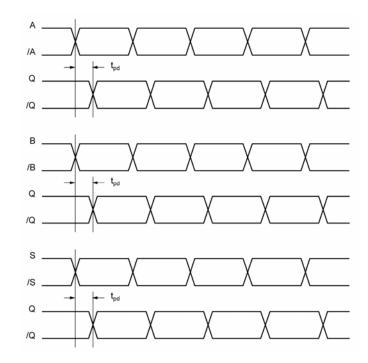
#### Notes:

- 7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- 8. Measured with 100mV input swing. See "Timing Diagrams" section for definition of parameters. High-frequency AC parameters are guaranteed by design and characterization.
- 9. Skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.
- 10. Random jitter is measured with a K28.7 comma detect character pattern, measured at 2.5Gbps/3.2Gbps.
- 11. Deterministic jitter is measured at 2.5Gbps/3.2Gbps with both K28.5 and 2<sup>23</sup>–1 PRBS pattern.
- 12. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, Tn–Tn–1 where T is the time between rising edges of the output signal.
- Total jitter definition: with an ideal clock input of frequency ≤ f<sub>MAX</sub>, no more than one output edge in 10<sup>12</sup> output edges will deviate by more than the specified peak-to-peak jitter value.

# **Functional Block Diagram**



# **Timing Diagram**



# Input and Output Stage Internal Termination

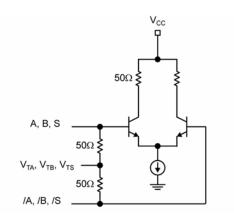


Figure 1a. Simplified Differential Input Stage

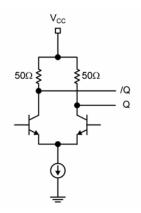


Figure 1b. Simplified Differential Output Stage

## **Definition of Single-Ended and Differential Swings**

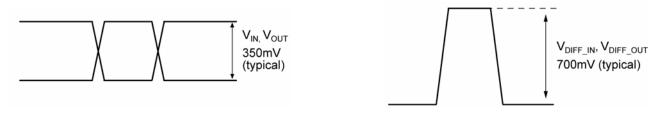
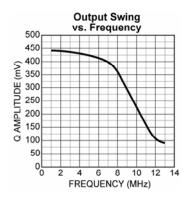
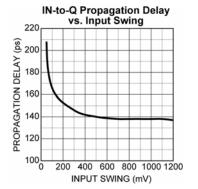


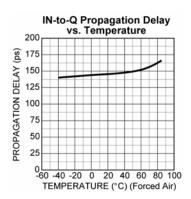
Figure 2a. Single-Ended Swing

Figure 2b. Differential Swing

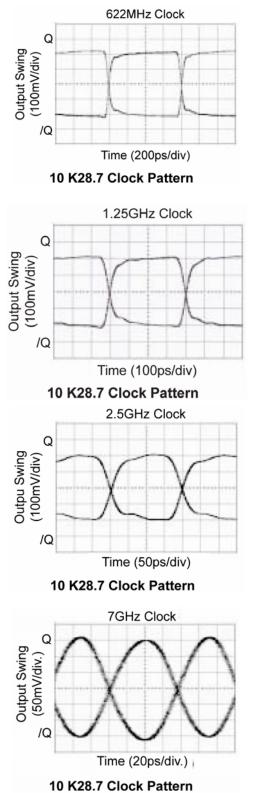
# **Typical Operating Characteristics**

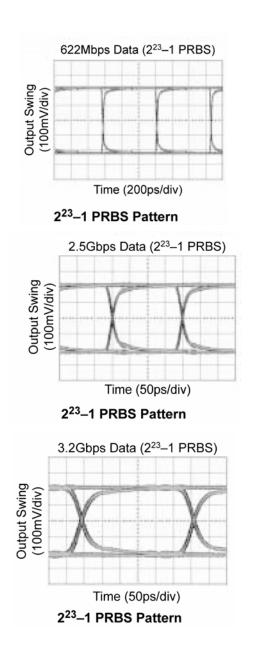




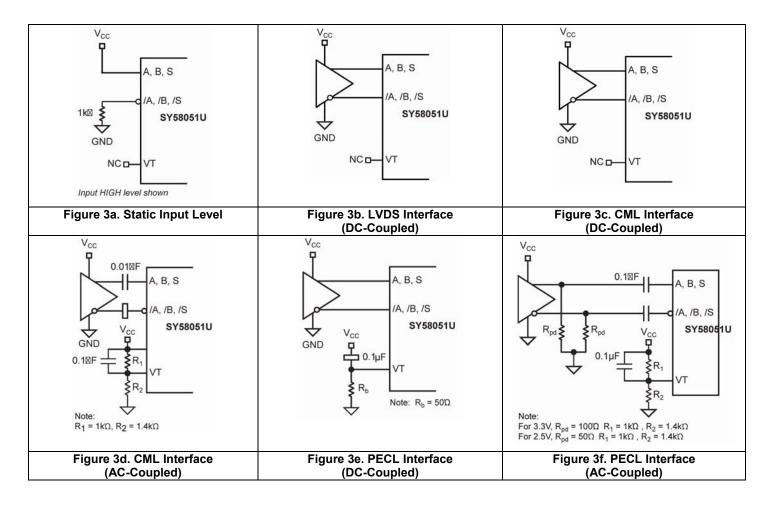


# Functional Characteristics





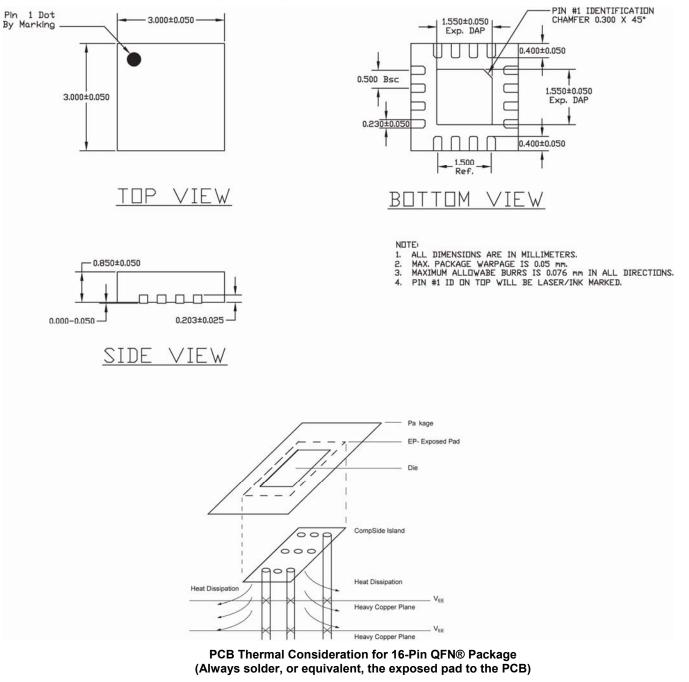
# **Input Interface Applications**



## **Related Product and Support Documentation**

Part Number	Function	Data Sheet Link
SY58016L	3.3V 10Gbps Differential CML Line Driver/Receiver with Internal Termination	http://www.micrel.com/product-info/products/sy58016l.shtml
SY58052U	10Gbps Clock/Data Retimer with 50Ω Input Termination	www.micrel.com/product-info/products/sy58052u.shtml
	QFN <sup>®</sup> Application Note	www.amkor.com/products/notes papers/MLF AppNote 0902.pdf
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

# 16-PIN *Micro*LeadFrame<sup>®</sup> (MLF-16)



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